

United States Patent [19]

Yu et al.

[54] METHOD TO MANUFACTURE DUAL DAMASCENE STRUCTURES BY UTILIZING SHORT RESIST SPACERS

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- [51] Int. Cl.⁷ H01L 21/4763
- [52] U.S. Cl. 438/622; 438/618; 438/634;
- - 438/634, 637, 671, 672, 675, 638

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[45]

Primary Examiner—Carl Whitehead, Jr. Assistant Examiner—Jamie L. Davis Attorney, Agent, or Firm—H. Donald Nelson

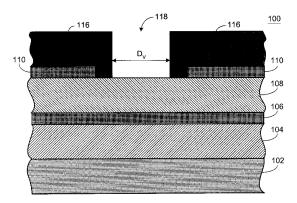
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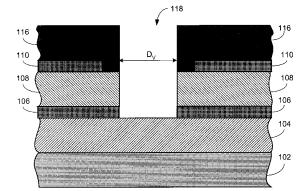
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[57] ABSTRACT

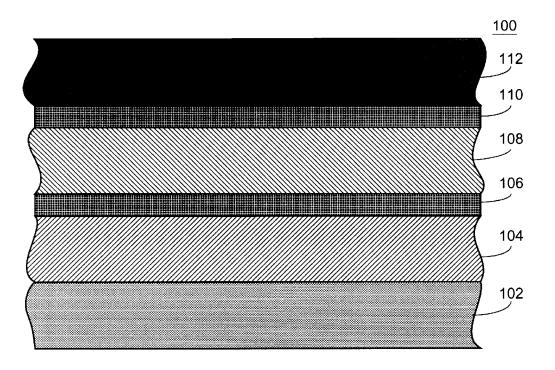
A method of manufacturing semiconductor devices wherein a partially completed semiconductor device having a first and second layer of interlayer dielectric and a first and second etch stop layer has the second etch stop layer masked and etched with an etch pattern having dimensions of the trench structure to be formed in the second interlayer dielectric. The second layer dielectric and first etch stop layer are then masked and etched with an etch pattern having dimensions of the via structure to be formed in the first interlayer dielectric. The remaining portions of the photoresist is removed and exposed portions of the second layer of interlayer dielectric and the first layer of interlayer dielectric are then etched simultaneously. The via structure and trench structure are then simultaneously filled with a conductive material.

6 Claims, 6 Drawing Sheets





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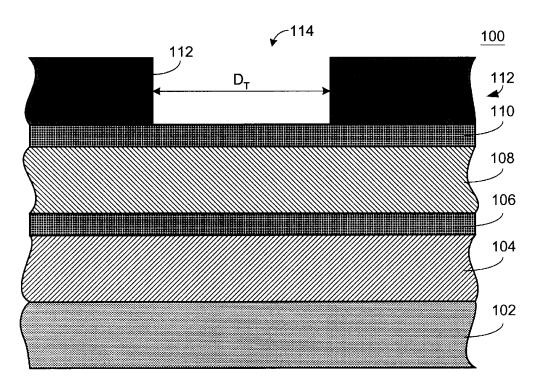


FIGURE 1B

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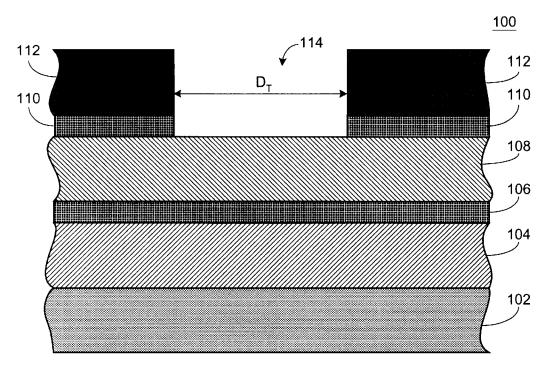


FIGURE 1C

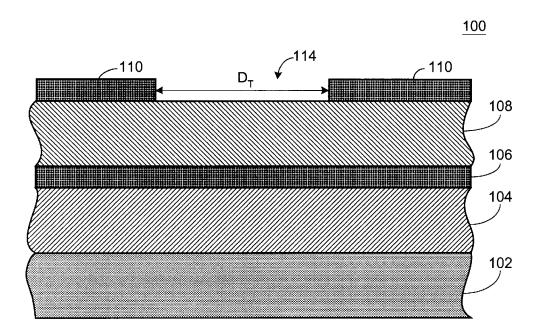
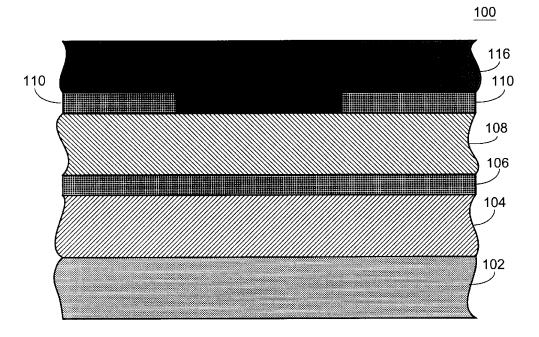
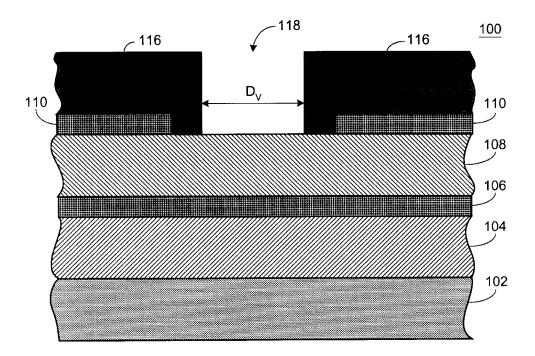


FIGURE 1D









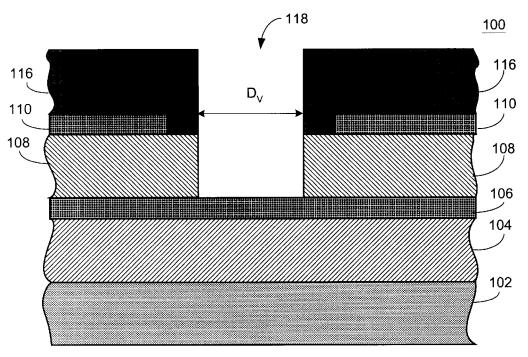
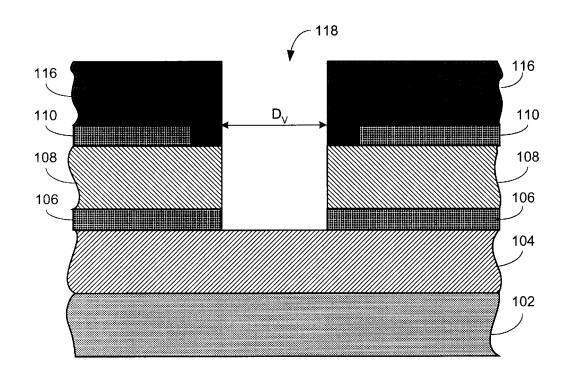


FIGURE 1G





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